

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT3124750

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Mitsuru Suda	10/10/2014
RECEIVING PARTY DATA	
Name:	NIPPON STEEL & SUMIKIN CHEMICAL CO., LTD.
Street Address:	14-1, SOTOKANDA 4-CHOME
City:	CHIYODA-KU, TOKYO
State/Country:	JAPAN
Postal Code:	101-0021
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14404255
CORRESPONDENCE DATA	
Fax Number:	(202)530-1281
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	2025301280
Email:	lcheng@chenglawgroup.com
Correspondent Name:	LEE CHENG
Address Line 1:	1100 17TH STREET N.W. STE 310
Address Line 4:	WASHINGTON, D.C. 20036
ATTORNEY DOCKET NUMBER:	NAN-0344
NAME OF SUBMITTER:	LEE CHENG
SIGNATURE:	/Lee Cheng/
DATE SIGNED:	11/26/2014
Total Attachments: 1	
source=NAN-0344_Executed_Assignment#page1.tif	

CHENG LAW GROUP, PLLC

Docket No. _____

U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter ASSIGNOR) by

[Insert
ASSIGNEE's
Name(s)
Address(es)]

NIPPON STEEL & SUMIKIN CHEMICAL CO., LTD.

of 14-1, Sotokanda 4-chome, Chiyoda-ku, Tokyo 101-0021 Japan

(hereinafter ASSIGNEE), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE all of the right, title and interest to the invention entitled

[Title of
Invention]

ORGANIC ELECTROLUMINESCENCE ELEMENT AND MATERIAL FOR ORGANIC
ELECTROLUMINESCENCE ELEMENT

[*If the assignment
is being filed
after the filing of the
application, this
section must be
completed]

for which application for Letters Patent of the United States was executed on even date herewith unless otherwise indicated below:

*filed on _____, Serial No. _____

(Cheng Law Group, PLLC is hereby authorized to insert the series code, serial number and/or filing date hereon, when known)

and all Letters Patent of the United States to be obtained therefor on said application or any continuation, division, renewal, substitute, reissue or reexamination thereof for the full term or terms for which the same may be granted.

The ASSIGNOR agrees to execute all papers necessary in connection with application and any continuing, divisional, reissue or reexamination applications thereof and also to execute separate assignments in connection with such applications as the ASSIGNEE may deem necessary or expedient.

The ASSIGNOR agrees to execute all papers necessary in connection with any interference, litigation, or other legal proceeding which may be declared concerning this application or any continuation, division, reissue or reexamination thereof or Letters Patent or reissue patent issued thereon and to cooperate with the ASSIGNEE in every way possible in obtaining and producing evidence and proceeding with such interference, litigation, or other legal proceeding.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

[Signature(s)
of Assignor(s)]

Mitsuru SUDA
(SIGNATURE)

Mitsuru SUDA

(TYPE NAME)

October 10, 2014

(DATE)

(SIGNATURE)

(TYPE NAME)

(DATE)

(SIGNATURE)

(TYPE NAME)

(DATE)

(SIGNATURE)

(TYPE NAME)

(DATE)